Type: Driven Synchronous Flyback
Output: 5V, 5A, 25W
External Adaptor: 24V & 48V

NOTES:
1. Build on HPA420A PCB using HPA420D BOM
2. T2 changed to JA4456-DL
3. Q1 changed to SIR422DP (Rev B)
4. D10 added to PCB
5. R100 added to PCB. Change connection to C8-2 (Rev B)
6. D15 changed to MURS120T3 (5MB package)
7. R12 changed to 1206 package
8. R17 changed to 22.1k (Rev B), R21 changed to 3320hm
9. R20 changed to 4.7ohm, R24 changed to 1.5k
10. C31 changed to 8.8nF
11. C100 (330pF) may be required for some applications
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